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### **Application Information**

Title Line One:: PACKAGE SEALING METHOD,  
Title Line Two:: MANUFACTURING METHOD OF ELECTRONIC  
Title Line Three:: DEVICE MODULES, SEALING APPARATUS,  
Title Line Four:: AND PACKAGED PRODUCTS  
Total Drawing Sheets:: 7  
Docket Number:: 108850

### **Prior Foreign Applications**

Foreign Application One:: 2000-066176  
Filing Date:: March 10, 2000  
Country:: JAPAN  
Priority Claimed:: YES  
Foreign Application Two:: 2001-051938  
Filing Date:: February 27, 2001  
Country:: JAPAN  
Priority Claimed:: YES